

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hideko ANDO	05/27/2008
RECEIVING PARTY DATA	
Name:	NEC Electronics Corporation
Street Address:	1753 Shimonumabe, Nakahara-ku
City:	Kawasaki, Kanagawa
State/Country:	JAPAN
Postal Code:	211-8668
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12146864
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NAME OF SUBMITTER:	Eric Jensen
Total Attachments: 1 source=ASSIGNMENT#page1.tif	

OP \$40.00 12146864

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PATENT
REEL: 021155 FRAME: 0699

ASSIGNMENT

WHEREAS, HIDEKO ANDO
of Kanagawa, Japan

has S invented certain new and useful improvements in
SEMICONDUCTOR DEVICE HAVING METAL CAP

for which I am about to make application for Letters
(I/we have made--or am/are about to make)
Patent of the United States of America;

AND WHEREAS, NEC Electronics Corporation, 1753 Shimonumabe,
Nakahara-ku, Kawasaki, Kanagawa 211-8668, Japan is
desirous of acquiring an interest therein and in the Letters Patent to be obtained therefor from the
United States;

NOW THEREFORE, be it known by all whom it may concern, that for and in consideration of
One Dollars (\$ 1.00)
to me in hand paid, the receipt of which is hereby acknowledged the said ASSIGNOR
have assigned, sold, and set over, and by these presents do hereby assign, sell, and set over unto the said
ASSIGNEE, NEC Electronics Corporation
* the full and exclusive right, title, and interest in and to the said invention,
as fully set forth and described in the:

Delete
inapplicable
wording

(a) specification prepared and executed by me on the 27th day of May, 2008,
(b) application filed on the _____ day of _____, _____, Serial No. _____,
preparatory to obtaining Letters Patent therefor; said invention, application and Letters Patent to be
held and enjoyed by the said ASSIGNEE, NEC Electronics Corporation
for their own use and behoof, and for their legal representatives, to the full end of the term
for which said Letters Patent are granted, as fully and entirely as the same would have been held by
me had this assignment and sale not been made.

IN TESTIMONY WHEREOF, I hereunto set my hand and affix my seal at
Kanagawa, Japan this 27th day of May, A.D. 2008

Hideko Ando
HIDEKO ANDO (Inventor's full Signature)

Witness:

Hajime Masuda